

1. General description

Passivated high commutation three quadrant triac in a SOT78 plastic package intended for use in circuits where high static and dynamic dV/dt and high di/dt can occur. This "series B" triac will commutate the full RMS current at the maximum rated junction temperature without the aid of a snubber.

2. Features and benefits

- 3Q technology for improved noise immunity
- High commutation capability with maximum false trigger immunity
- High immunity to false turn-on by dV/dt
- High voltage capability
- Planar passivated for voltage ruggedness and reliability
- Triggering in three quadrants only

3. Applications

- Electronic thermostats (heating and cooling)
- High power motor controls e.g. washing machines and vacuum cleaners
- Rectifier-fed DC inductive loads e.g. DC motors and solenoids

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	-	800	V
$I_{T(RMS)}$	RMS on-state current	full sine wave; $T_{mb} \leq 101^\circ\text{C}$; Fig. 1 ; Fig. 2 ; Fig. 3	-	-	16	A
I_{TSM}	non-repetitive peak on-state current	full sine wave; $T_{j(\text{init})} = 25^\circ\text{C}$; $t_p = 20 \text{ ms}$; Fig. 4 ; Fig. 5	-	-	140	A
		full sine wave; $T_{j(\text{init})} = 25^\circ\text{C}$; $t_p = 16.7 \text{ ms}$	-	-	150	A
T_j	junction temperature		-	-	125	°C
Static characteristics						
I_{GT}	gate trigger current	$V_D = 12 \text{ V}$; $I_T = 0.1 \text{ A}$; T2+ G+; $T_j = 25^\circ\text{C}$; Fig. 7	2	-	50	mA
		$V_D = 12 \text{ V}$; $I_T = 0.1 \text{ A}$; T2+ G-; $T_j = 25^\circ\text{C}$; Fig. 7	2	-	50	mA
		$V_D = 12 \text{ V}$; $I_T = 0.1 \text{ A}$; T2- G-; $T_j = 25^\circ\text{C}$; Fig. 7	2	-	50	mA
I_H	holding current	$V_D = 12 \text{ V}$; $T_j = 25^\circ\text{C}$; Fig. 9	-	-	60	mA
V_T	on-state voltage	$I_T = 18 \text{ A}$; $T_j = 25^\circ\text{C}$; Fig. 10	-	1.3	1.5	V
Dynamic characteristics						
dV_D/dt	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}$; $T_j = 125^\circ\text{C}$; ($V_{DM} = 67\%$ of V_{DRM}); exponential waveform; gate open circuit	1000	-	-	V/μs
di_{com}/dt	rate of change of commutating current	$V_D = 400 \text{ V}$; $T_j = 125^\circ\text{C}$; $I_{T(RMS)} = 16 \text{ A}$; $dV_{com}/dt = 20 \text{ V/}\mu\text{s}$; (snubberless condition); gate open circuit	20	-	-	A/ms

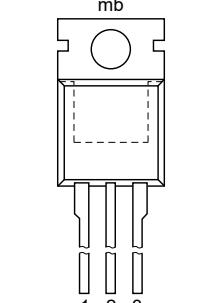
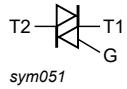
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
		$V_D = 12 \text{ V}$; $I_T = 0.1 \text{ A}$; $T_2 - G-$; $T_j = 25^\circ\text{C}$; Fig. 7		2	-	50	mA
I_H	holding current	$V_D = 12 \text{ V}$; $T_j = 25^\circ\text{C}$; Fig. 9		-	-	60	mA
V_T	on-state voltage	$I_T = 18 \text{ A}$; $T_j = 25^\circ\text{C}$; Fig. 10		-	1.3	1.5	V

Dynamic characteristics

dV_D/dt	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}$; $T_j = 125^\circ\text{C}$; ($V_{DM} = 67\%$ of V_{DRM}); exponential waveform; gate open circuit		1000	-	-	V/ μs
dI_{com}/dt	rate of change of commutating current	$V_D = 400 \text{ V}$; $T_j = 125^\circ\text{C}$; $I_{T(RMS)} = 16 \text{ A}$; $dV_{com}/dt = 20 \text{ V}/\mu\text{s}$; (snubberless condition); gate open circuit		20	-	-	A/ms

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	T1	main terminal 1		
2	T2	main terminal 2		
3	G	gate		
mb	T2	mounting base; main terminal 2	 TO-220AB (SOT78)	 <i>sym051</i>

6. Ordering information

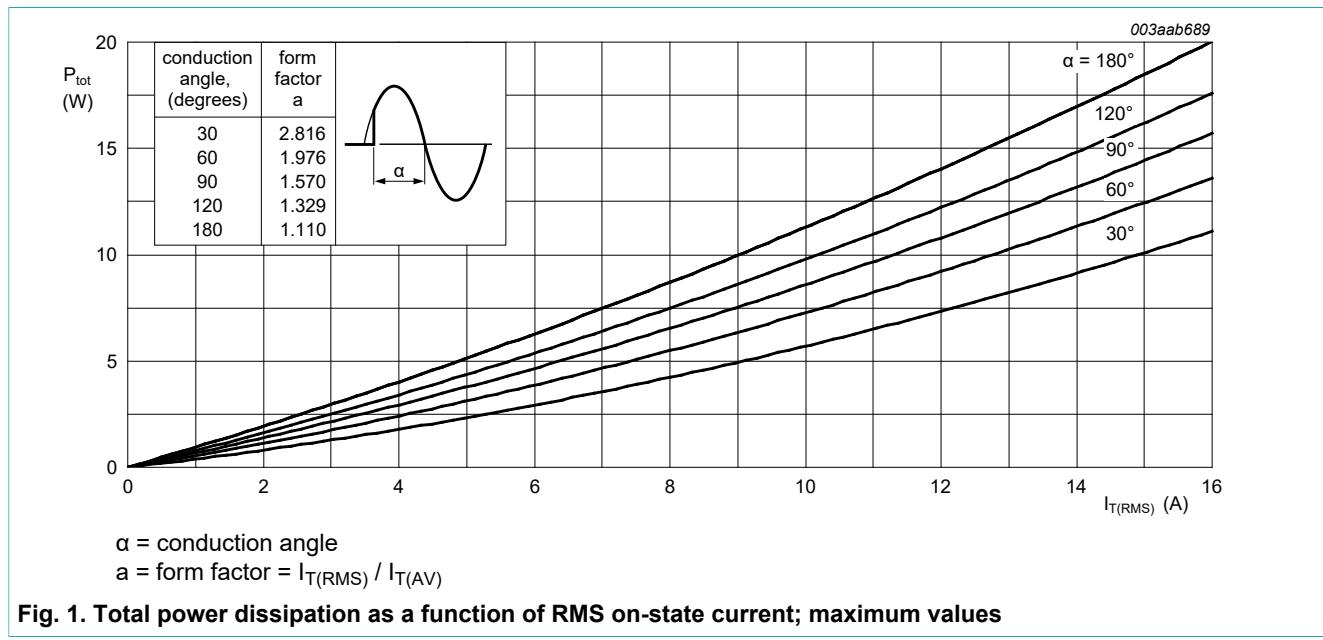
Table 3. Ordering information

Type number	Package		
	Name	Description	Version
T316-800B	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

7. Limiting values

Table 4. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	800	V
$I_{T(RMS)}$	RMS on-state current	full sine wave; $T_{mb} \leq 101^\circ C$; Fig. 1; Fig. 2; Fig. 3	-	16	A
I_{TSM}	non-repetitive peak on-state current	full sine wave; $T_{j(init)} = 25^\circ C$; $t_p = 20\text{ ms}$; Fig. 4; Fig. 5	-	140	A
		full sine wave; $T_{j(init)} = 25^\circ C$; $t_p = 16.7\text{ ms}$	-	150	A
I^2t	I^2t for fusing	$t_p = 10\text{ ms}$; SIN	-	98	A^2s
dI_T/dt	rate of rise of on-state current	$I_G = 0.2\text{ A}$	-	100	$A/\mu s$
I_{GM}	peak gate current		-	2	A
P_{GM}	peak gate power		-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.5	W
T_{stg}	storage temperature		-40	150	$^\circ C$
T_j	junction temperature		-	125	$^\circ C$



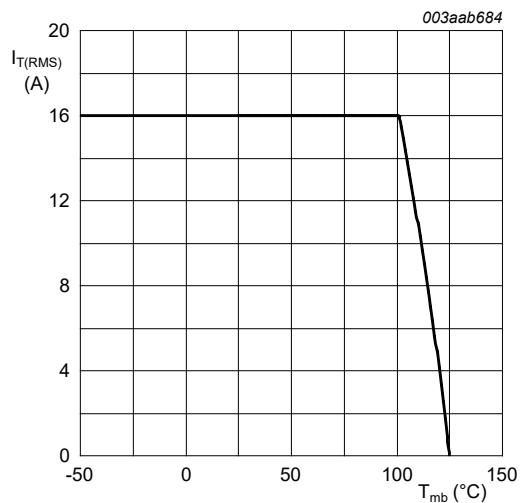
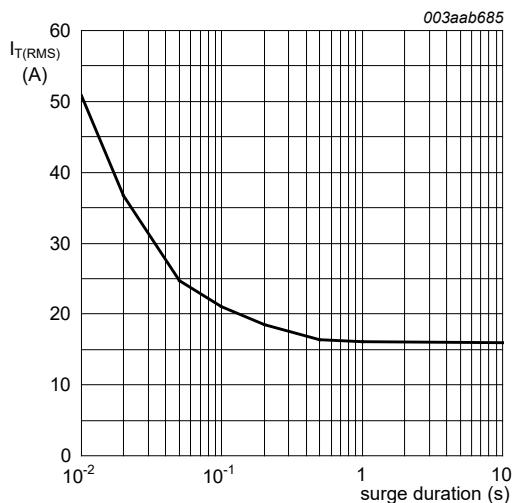


Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values



f = 50 Hz; T_{mb} = 101 °C

Fig. 3. RMS on-state current as a function of surge duration; maximum values

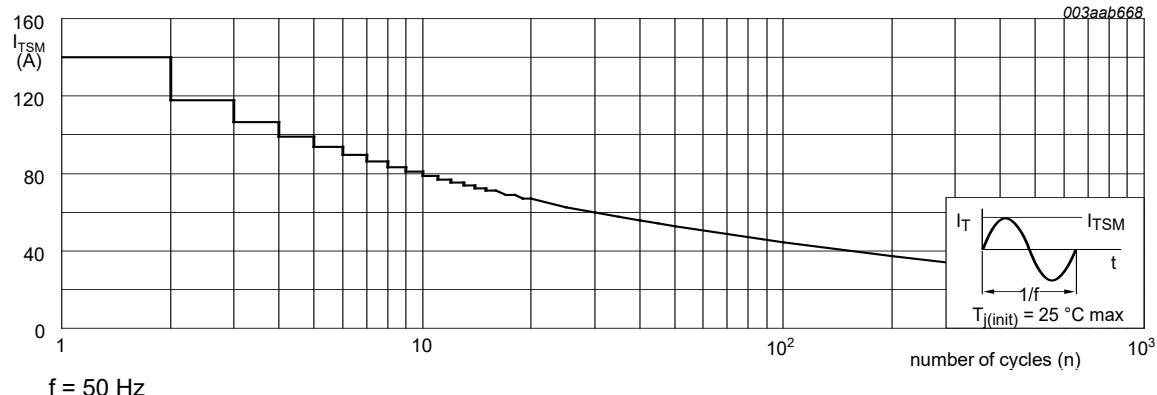


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

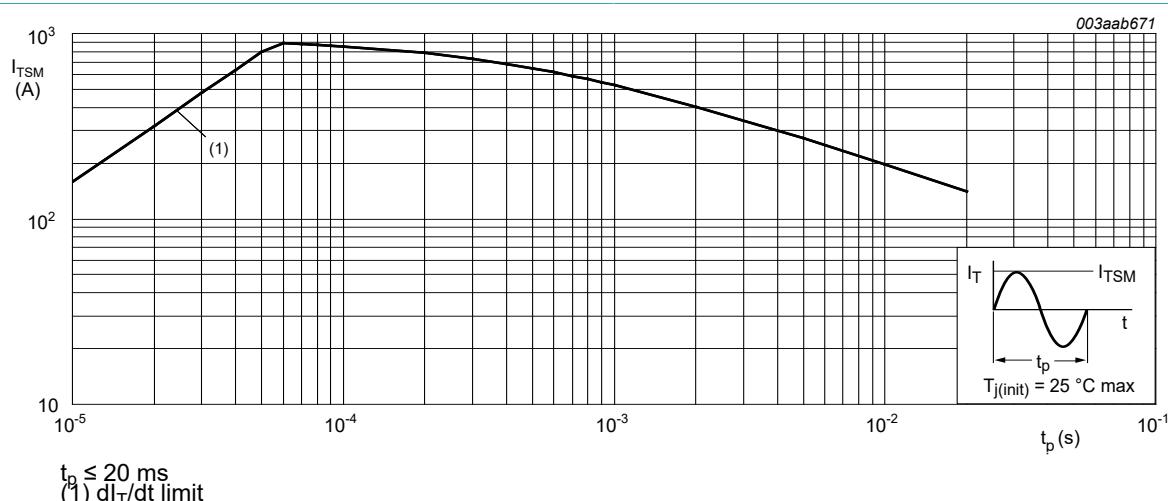
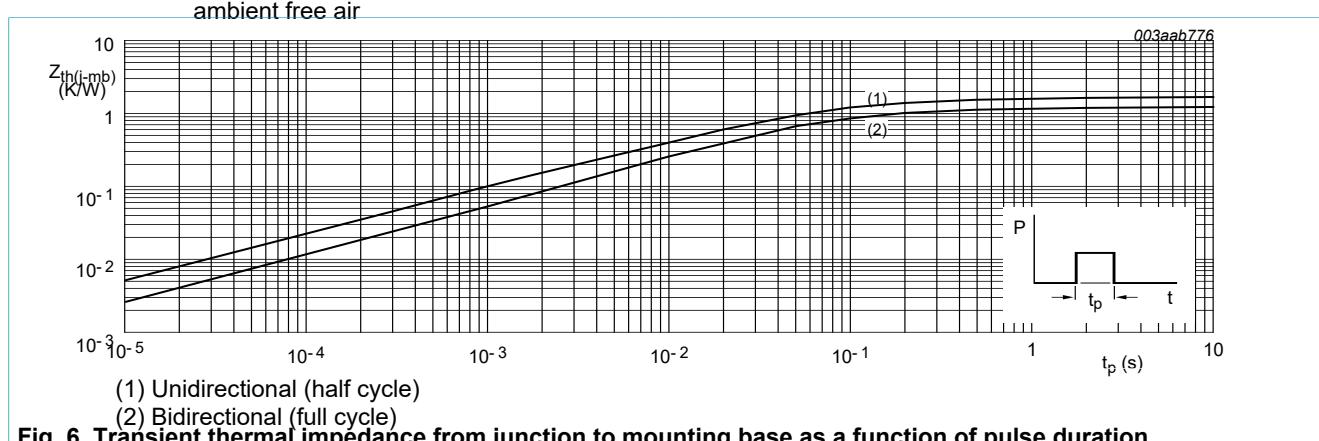


Fig. 5. Non-repetitive peak on-state current as a function of pulse duration; maximum values

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	full cycle; Fig. 6	-	-	1.2	K/W
		half cycle; Fig. 6	-	-	1.7	K/W
$R_{th(j-a)}$	thermal base resistance from junction to ambient free air	in free air	-	60	-	K/W



9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
I_{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2+ G+$; $T_j = 25^\circ\text{C}$; Fig. 7	2	-	50	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2+ G-$; $T_j = 25^\circ\text{C}$; Fig. 7	2	-	50	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2- G-$; $T_j = 25^\circ\text{C}$; Fig. 7	2	-	50	mA
I_L	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2+ G+$; $T_j = 25^\circ\text{C}$; Fig. 8	-	-	60	mA
		$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2+ G-$; $T_j = 25^\circ\text{C}$; Fig. 8	-	-	90	mA
		$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2- G-$; $T_j = 25^\circ\text{C}$; Fig. 8	-	-	60	mA
I_H	holding current	$V_D = 12 \text{ V}; T_j = 25^\circ\text{C}$; Fig. 9	-	-	60	mA
V_T	on-state voltage	$I_T = 18 \text{ A}; T_j = 25^\circ\text{C}$; Fig. 10	-	1.3	1.5	V
V_{GT}	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25^\circ\text{C}$; Fig. 11	-	0.8	1	V
		$V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_j = 125^\circ\text{C}$; Fig. 11	0.25	0.4	-	V
I_D	off-state current	$V_D = 800 \text{ V}; T_j = 125^\circ\text{C}$	-	0.1	0.5	mA
Dynamic characteristics						
dV_D/dt	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}; T_j = 125^\circ\text{C}$; ($V_{DM} = 67\%$ of V_{DRM}); exponential waveform; gate open circuit	1000	-	-	V/ μ s
dl_{com}/dt	rate of change of commutating current	$V_D = 400 \text{ V}; T_j = 125^\circ\text{C}$; $I_{T(RMS)} = 16 \text{ A}$; $dV_{com}/dt = 20 \text{ V}/\mu\text{s}$; (snubberless condition); gate open circuit	20	-	-	A/ms

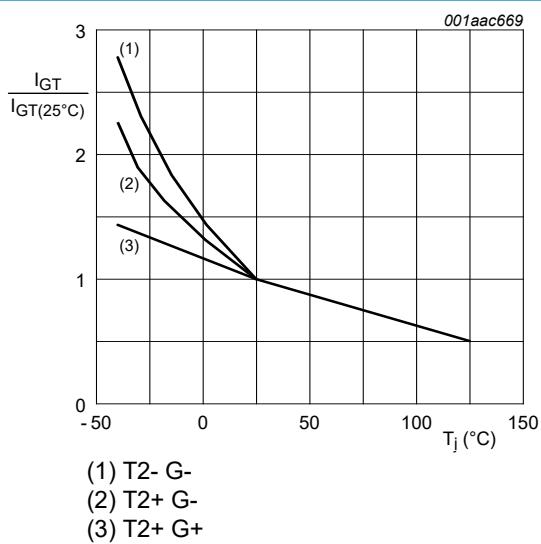


Fig. 7. Normalized gate trigger current as a function of junction temperature

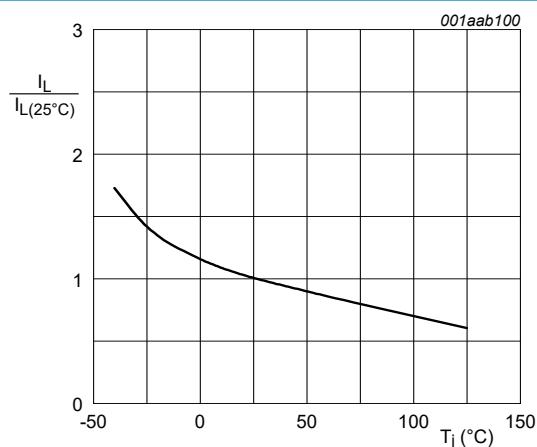


Fig. 8. Normalized latching current as a function of junction temperature

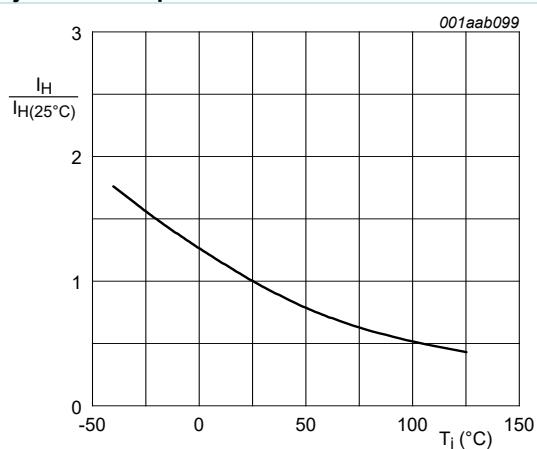
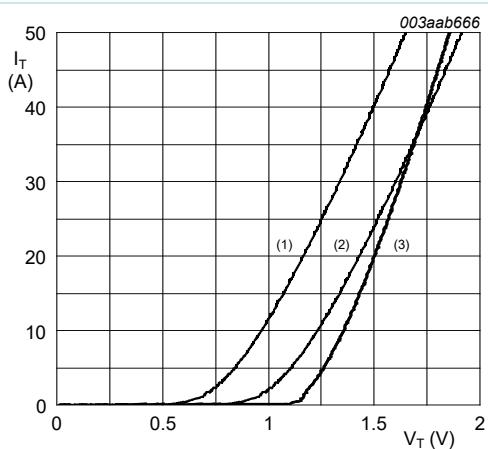


Fig. 9. Normalized holding current as a function of junction temperature



$V_o = 1.024 \text{ V}; R_s = 0.021 \Omega$
 (1) $T_j = 125^\circ\text{C}$; typical values
 (2) $T_j = 125^\circ\text{C}$; maximum values
 (3) $T_j = 25^\circ\text{C}$; maximum values

Fig. 10. On-state current as a function of on-state voltage

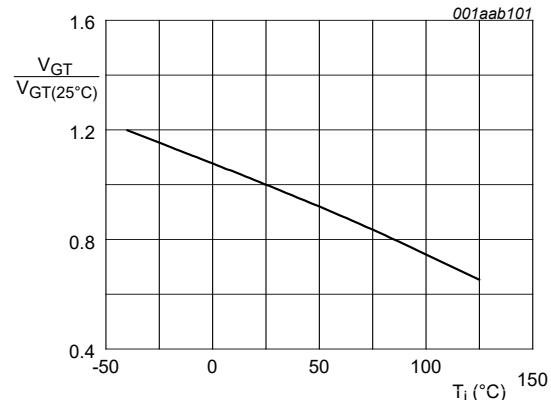
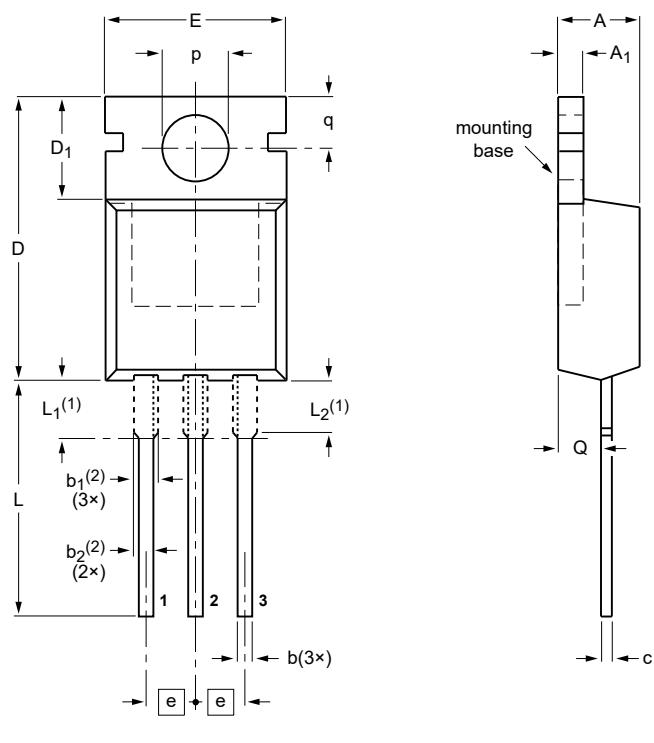


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

10. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78



0 5 10 mm
scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b	b ₁ (2)	b ₂ (2)	c	D	D ₁	E	e	L	L ₁ (1)	L ₂ (1) max.	p	q	Q
mm	4.7	1.40	0.9	1.6	1.3	0.7	16.0	6.6	10.3	2.54	15.0	3.30	3.0	3.8	3.0	2.6
	4.1	1.25	0.6	1.0	1.0	0.4	15.2	5.9	9.7		12.8	2.79		3.5	2.7	2.2

Notes

1. Lead shoulder designs may vary.
2. Dimension includes excess dambar.

IMPORTANT NOTICE – PLEASE READ CAREFULLY

SZGKTMicroelectronics NV and its subsidiaries reserve the right to make changes, corrections, enhancements, modifications, and improvements to SZGKT.